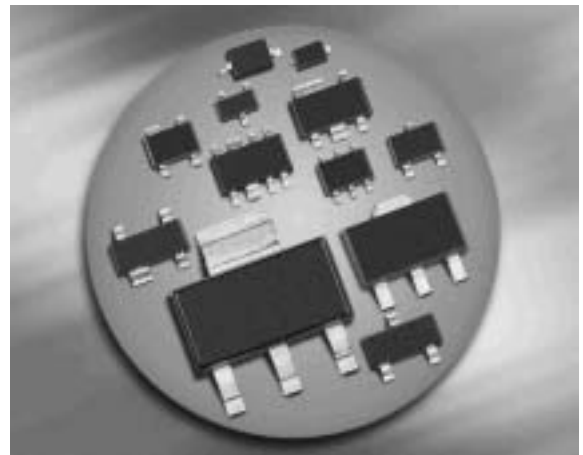
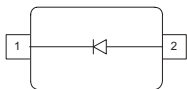


## Silicon Schottky Diode

- Medium current rectifier Schottky diode
- Low forward voltage at 200mA
- High reverse voltage
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



## BAS52-02V



**ESD** (Electrostatic discharge) sensitive device, observe handling precaution!

| Type      | Package | Configuration | Marking |
|-----------|---------|---------------|---------|
| BAS52-02V | SC79    | single        | y       |

**Maximum Ratings** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                          | Symbol    | Value       | Unit             |
|--------------------------------------------------------------------|-----------|-------------|------------------|
| Diode reverse voltage                                              | $V_R$     | 45          | V                |
| Forward current                                                    | $I_F$     | 750         | mA               |
| Average rectified forward current (50/60Hz, sinus)                 | $I_{FAV}$ | 500         | mA               |
| Non-repetitive peak surge forward current<br>$t = 100 \mu\text{s}$ | $I_{FSM}$ | 2000        |                  |
| Total power dissipation<br>$T_S \leq 110^\circ\text{C}$            | $P_{tot}$ | 500         | mW               |
| Junction temperature                                               | $T_j$     | 150         | $^\circ\text{C}$ |
| Storage temperature                                                | $T_{stg}$ | -65 ... 150 |                  |

## Thermal Resistance

| Parameter                                | Symbol     | Value     | Unit |
|------------------------------------------|------------|-----------|------|
| Junction - soldering point <sup>2)</sup> | $R_{thJS}$ | $\leq 60$ | K/W  |

<sup>1)</sup>Pb-containing package may be available upon special request

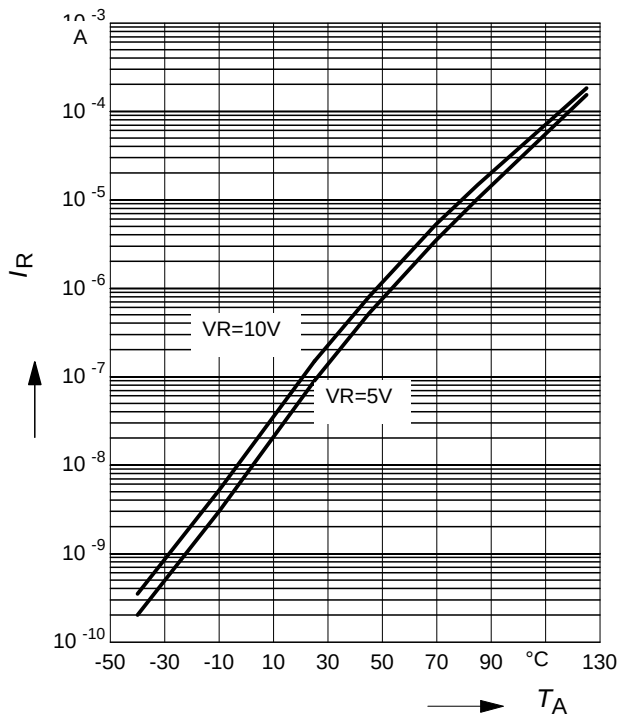
<sup>2)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                             | Symbol | Values |      |      | Unit          |
|-------------------------------------------------------|--------|--------|------|------|---------------|
|                                                       |        | min.   | typ. | max. |               |
| DC Characteristics                                    |        |        |      |      |               |
| Reverse current                                       | $I_R$  |        |      |      | $\mu\text{A}$ |
| $V_R = 45\text{ V}$                                   |        | -      | -    | 10   |               |
| $V_R = 5\text{ V}, T_A = 70\text{ }^{\circ}\text{C}$  |        | -      | -    | 30   |               |
| $V_R = 10\text{ V}$                                   |        | -      | -    | 1    |               |
| $V_R = 10\text{ V}, T_A = 85\text{ }^{\circ}\text{C}$ |        | -      | -    | 80   |               |
| Forward voltage                                       | $V_F$  |        |      |      | $\text{mV}$   |
| $I_F = 10\text{ mA}$                                  |        | -      | 335  | 420  |               |
| $I_F = 100\text{ mA}$                                 |        | -      | 430  | 530  |               |
| $I_F = 200\text{ mA}$                                 |        | 400    | 500  | 600  |               |
| AC Characteristics                                    |        |        |      |      |               |
| Diode capacitance                                     | $C_T$  | -      | 5    | 10   | $\text{pF}$   |
| $V_R = 10\text{ V}, f = 1\text{ MHz}$                 |        |        |      |      |               |

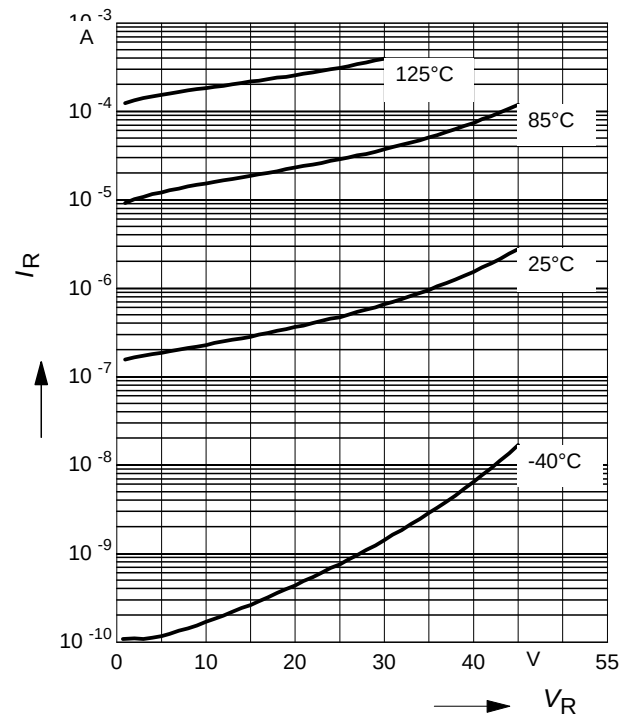
**Reverse current  $I_R = f(T_A)$**

$V_R$  = Parameter



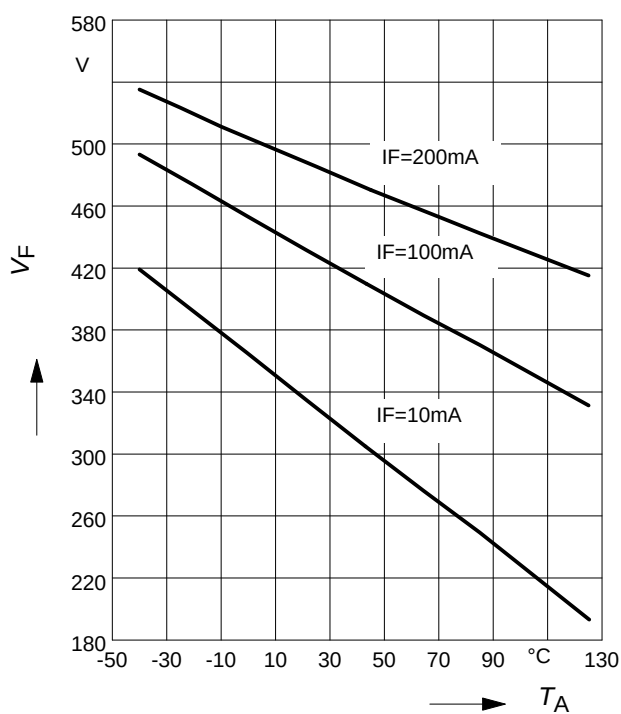
**Reverse current  $I_R = f(V_R)$**

$T_A$  = Parameter



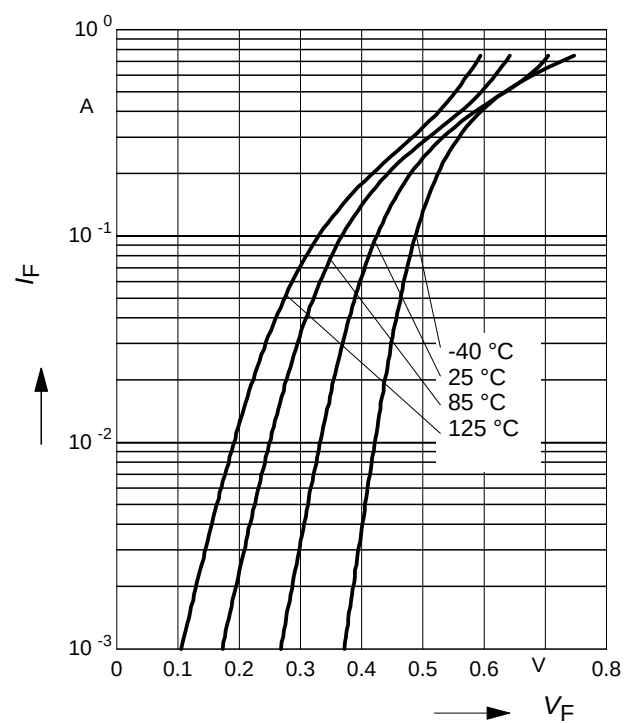
**Forward Voltage  $V_F = f(T_A)$**

$I_F$  = Parameter



**Forward current  $I_F = f(V_F)$**

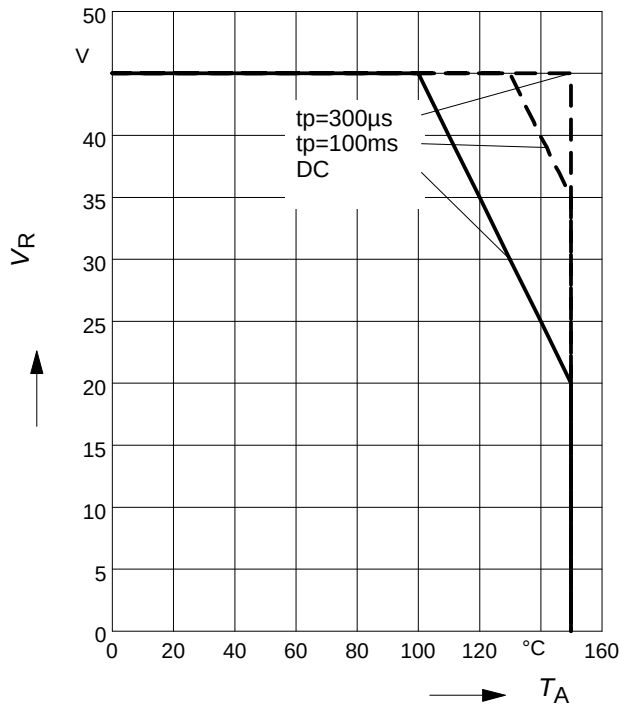
$T_A$  = Parameter



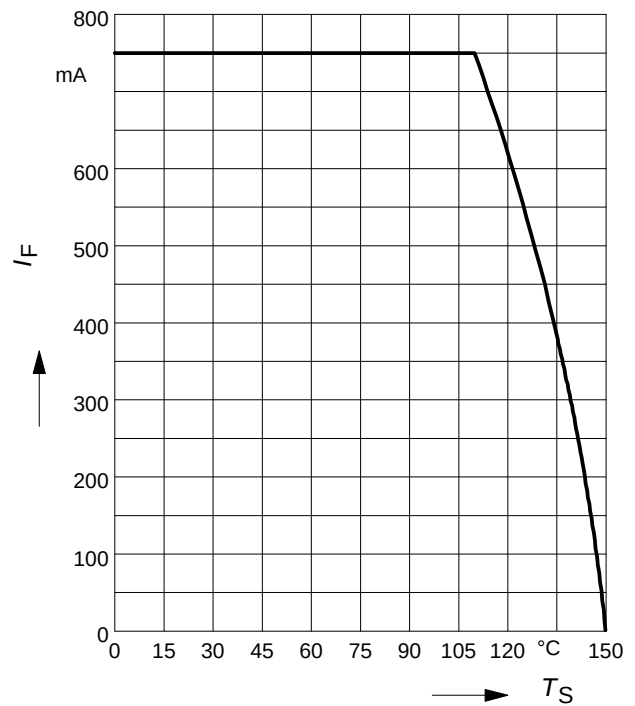
### Permissible Reverse voltage $V_R = f(T_A)$

$t_p$  = Parameter

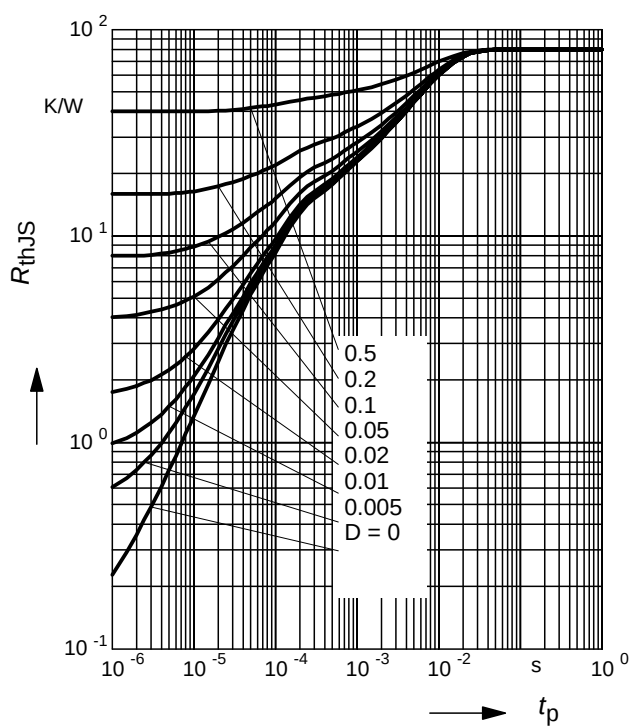
Duty cycle < 0.01



### Forward current $I_F = f(T_S)$

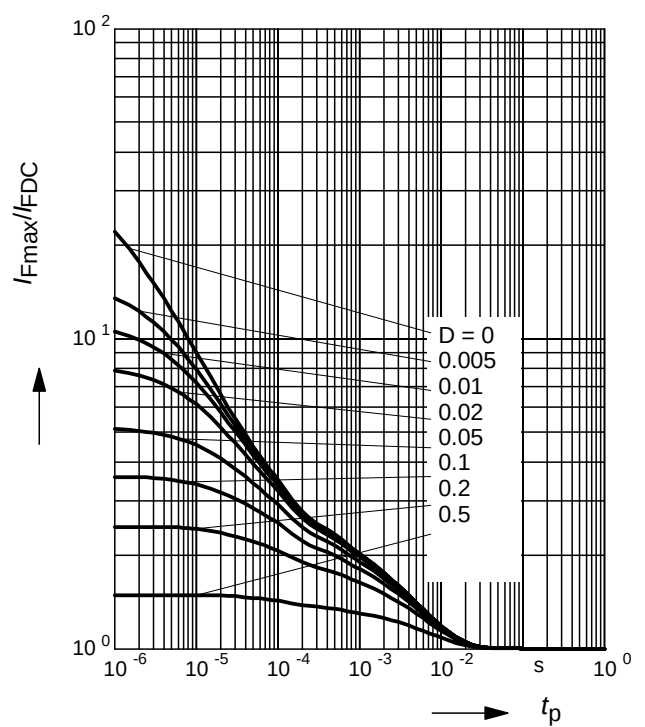


### Permissible Puls Load $R_{thJS} = f(t_p)$

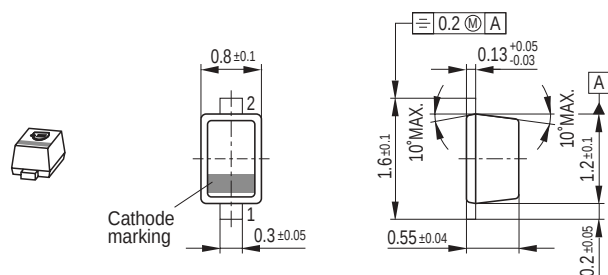


### Permissible Pulse Load

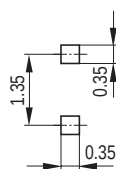
$I_{Fmax}/I_{FDC} = f(t_p)$



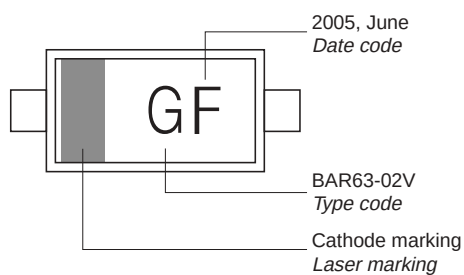
## Package Outline



## Foot Print

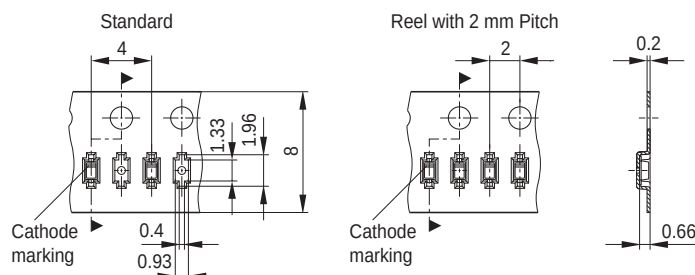


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)  
 Reel ø330 mm = 10.000 Pieces/Reel



Date Code marking for discrete packages with one digit (SCD80, SC79, SC75<sup>1)</sup>) CES-Code

| Month | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| 01    | a    | p    | A    | P    | a    | p    | A    | P    | a    | p    | A    | P    |
| 02    | b    | q    | B    | Q    | b    | q    | B    | Q    | b    | q    | B    | Q    |
| 03    | c    | r    | C    | R    | c    | r    | C    | R    | c    | r    | C    | R    |
| 04    | d    | s    | D    | S    | d    | s    | D    | S    | d    | s    | D    | S    |
| 05    | e    | t    | E    | T    | e    | t    | E    | T    | e    | t    | E    | T    |
| 06    | f    | u    | F    | U    | f    | u    | F    | U    | f    | u    | F    | U    |
| 07    | g    | v    | G    | V    | g    | v    | G    | V    | g    | v    | G    | V    |
| 08    | h    | x    | H    | X    | h    | x    | H    | X    | h    | x    | H    | X    |
| 09    | j    | y    | J    | Y    | j    | y    | J    | Y    | j    | y    | J    | Y    |
| 10    | k    | z    | K    | Z    | k    | z    | K    | Z    | k    | z    | K    | Z    |
| 11    | l    | 2    | L    | 4    | l    | 2    | L    | 4    | l    | 2    | L    | 4    |
| 12    | n    | 3    | N    | 5    | n    | 3    | N    | 5    | n    | 3    | N    | 5    |

1) New Marking Layout for SC75, implemented at October 2005.

Edition 2006-02-01

Published by

Infineon Technologies AG

81726 München, Germany

© Infineon Technologies AG 2007.

All Rights Reserved.

### **Attention please!**

The information given in this dokument shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie"). With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

### **Information**

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office ([www.infineon.com](http://www.infineon.com)).

### **Warnings**

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system.

Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.